

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company	 STMicroelectronics International N.V
1.2 PCN No.	POWER AND DISCRETES/25/15503
1.3 Title of PCN	Wafer manufacturing Transfer for Automotive Common Mode Filters and ESD protection from ST Tours (France) to ST Singapore
1.4 Product Category	Common Mode Filters and ESD protection
1.5 Issue date	2025-07-24

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Stephane CHAMARD
2.1.2 Marketing Manager	Philippe LEGER
2.1.3 Quality Manager	Jean-Paul REBRASSE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Manufacturing reshaping program	Manufacturing reshaping program	ST Tours (France)

4. Description of change

	Old	New
4.1 Description	Wafer Manufacturing location in ST Tours (France)	Wafer Manufacturing location in ST Singapore
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	Following Corporate PCI 15383 (Early Notification), about Company reshaping program, please be informed that wafer manufacturing line for Automotive Common Mode Filters and ESD protection will be transferred from ST tours (France) to ST Singapore.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	Traceability of the change will be ensured by Finished Good/Type (Beginning with O letter) printed on carton labels.
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7. Timing / schedule

7.1 Date of qualification results	2027-03-31
7.2 Intended start of delivery	2027-09-30
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

15503 Public product.pdf
15503 Transfer wafer manufacturing Automotive VLCT.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	ECMF04-4HSWM10Y	
	ECMF2-40A100M6Y	
	ECMF4-2459A6M10Y	
	HSP051-2W3Y	

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